

FIG. 1

FIG. 2

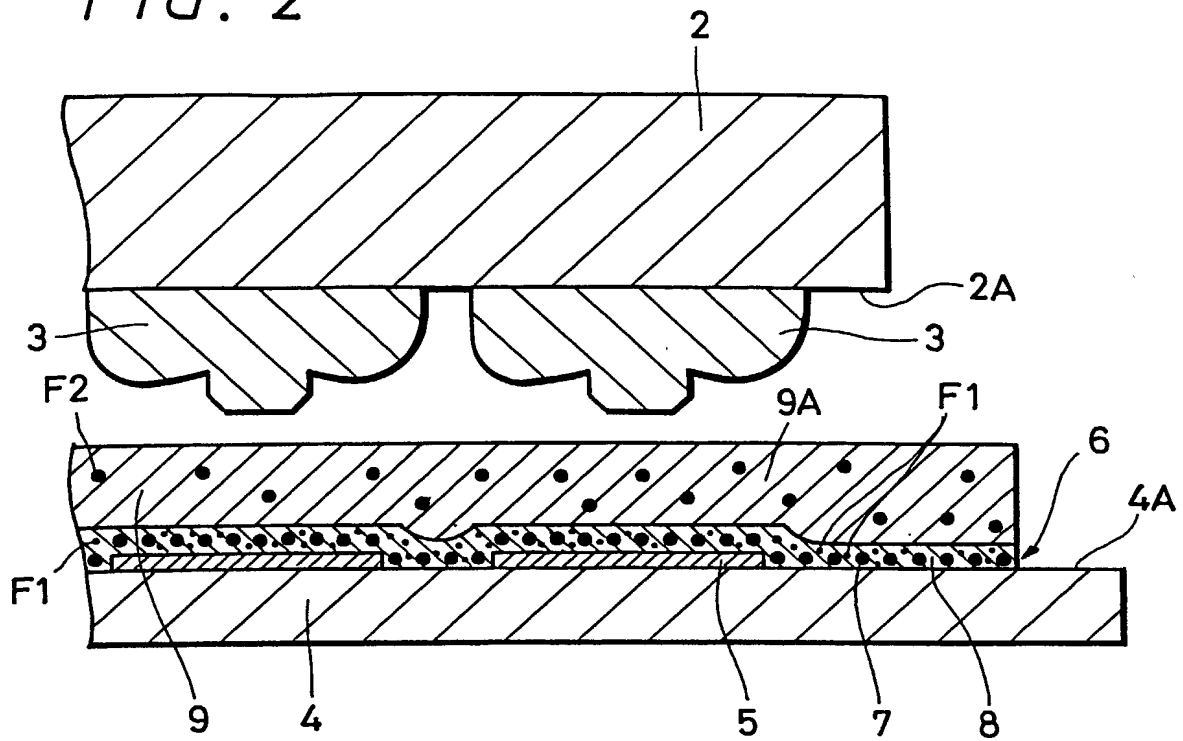


FIG. 3

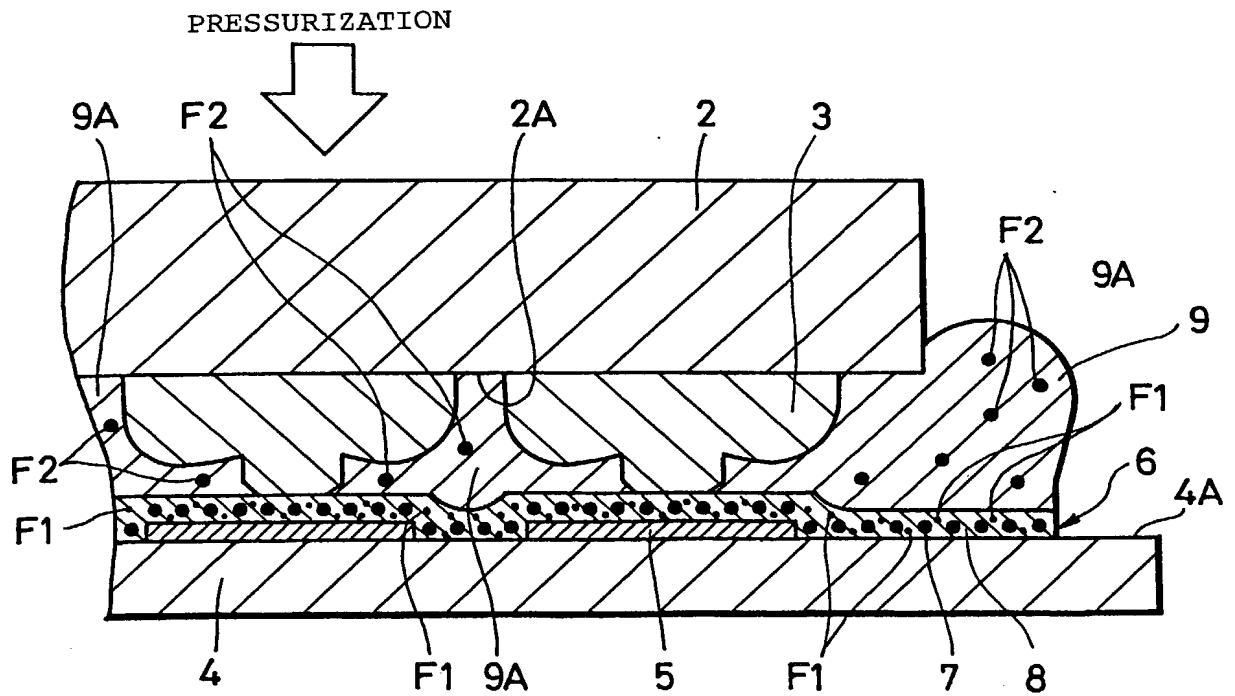


FIG. 6

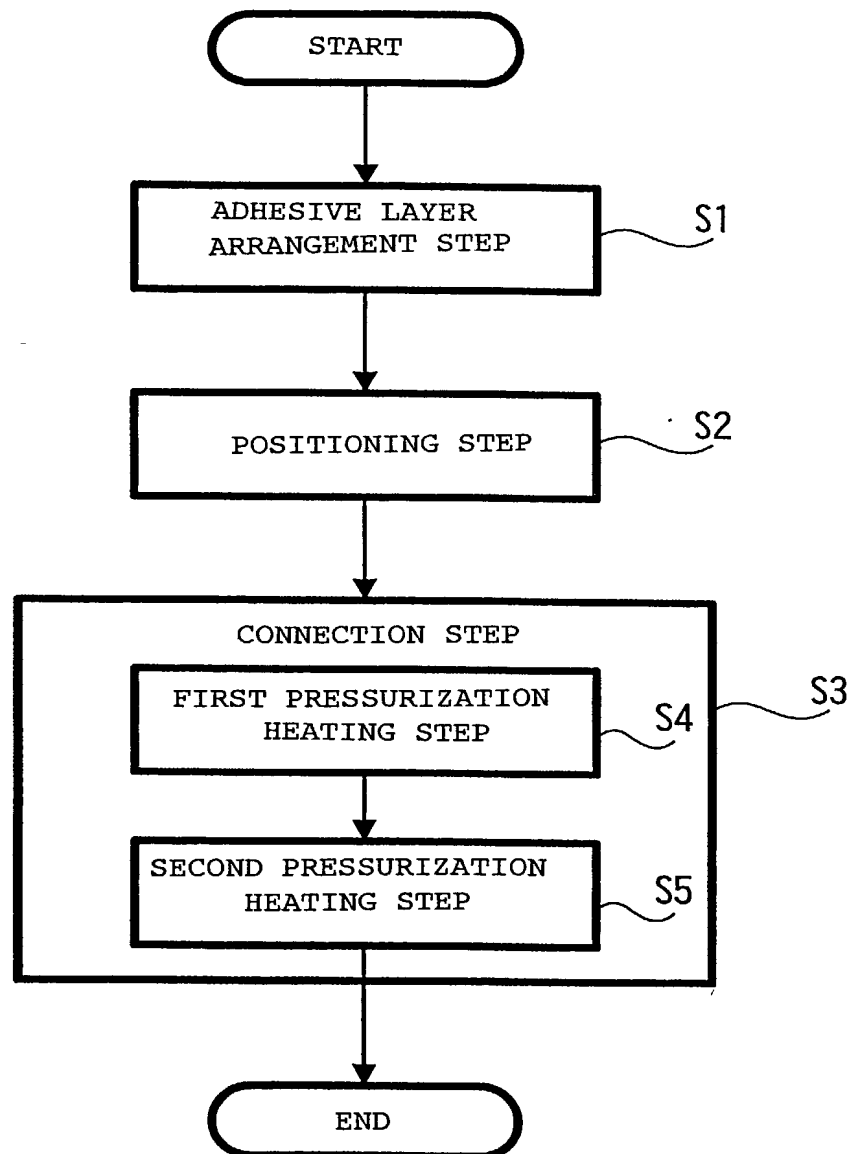


FIG. 7

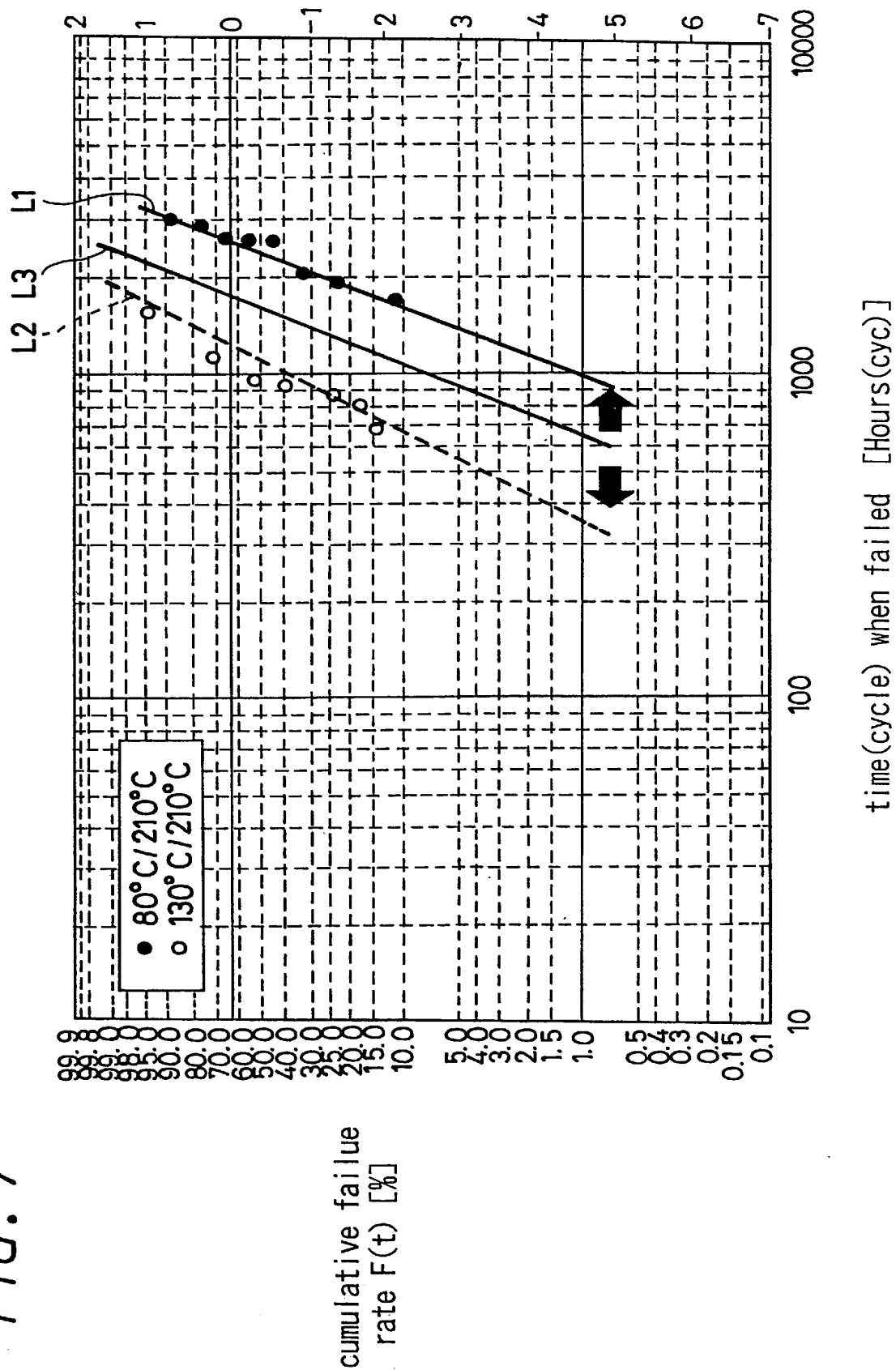
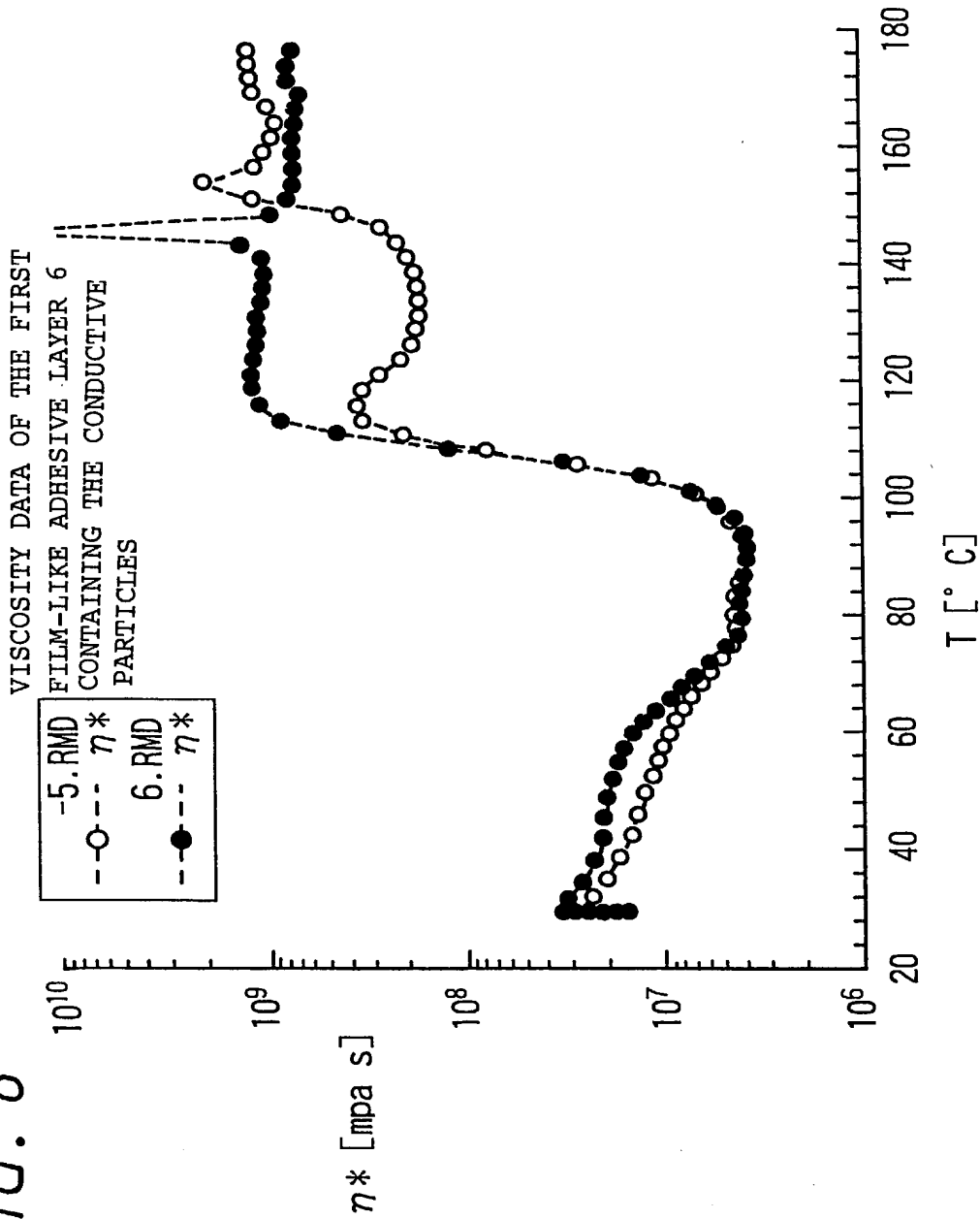
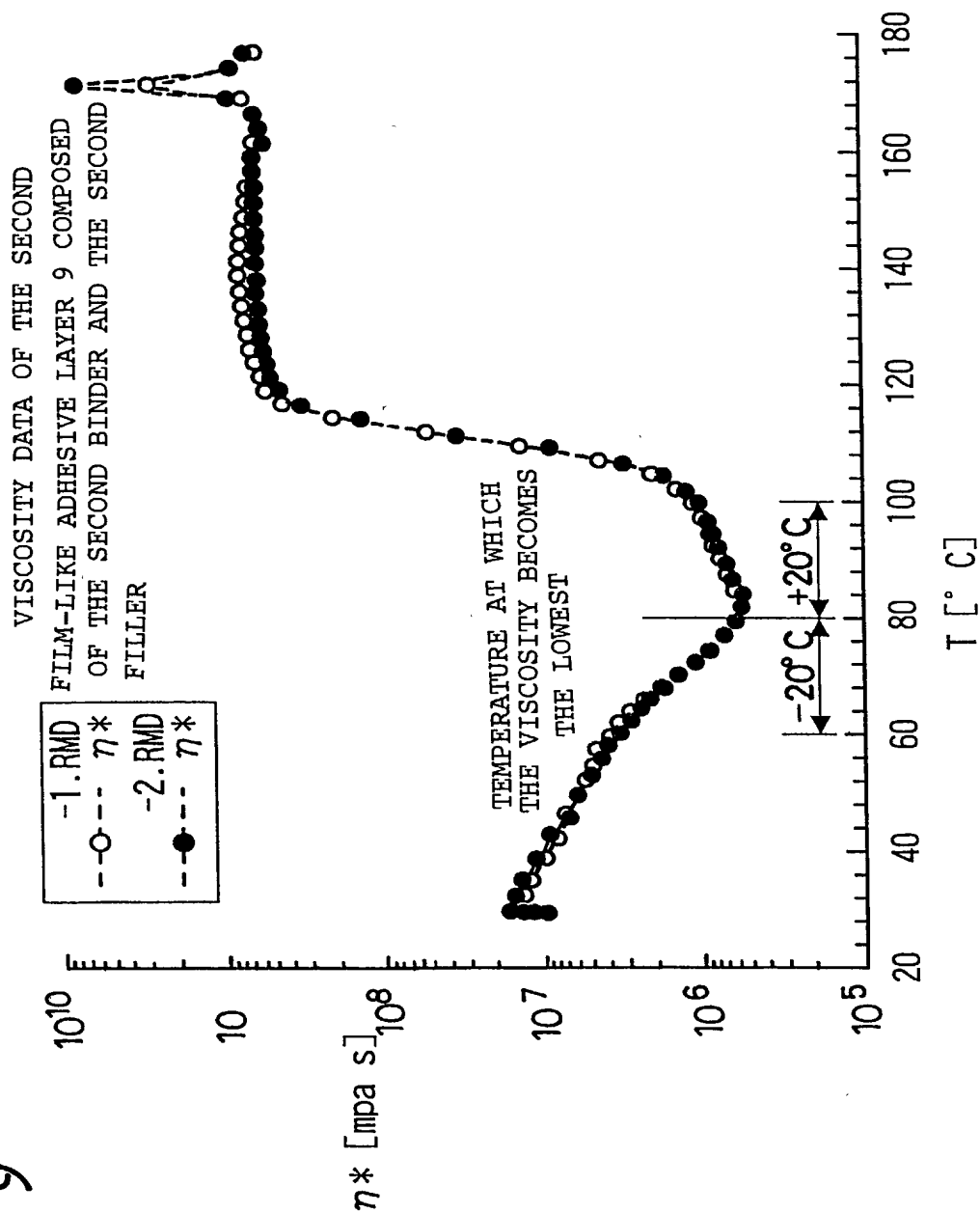


FIG. 8



RM 3.44P Sensor system: PP20(0.2600mm) System: RS75
 1: OSC-Time 5000.Pa 1.000Hz 30.00 ° C
 2: OSC-Temp-ramp 5000.Pa 1.000Hz 30.00-180.0 ° C 15.00min

FIG. 9



RM 3.44P Sensor system : PP20(0.2600mm) System : RS75
 1 : OSC-Time 5000.Pa 1.000Hz 30.00 ° C
 2 : OSC-Temp-ramp 5000.Pa 1.000Hz 30.00-180.0 ° C 15.00min

FIG. 10A

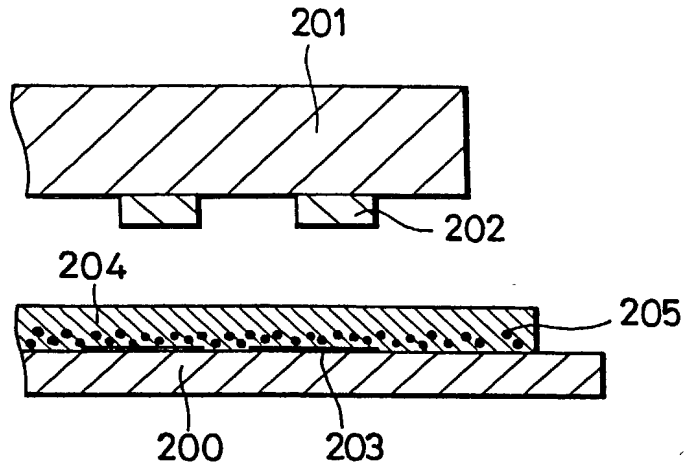


FIG. 10B

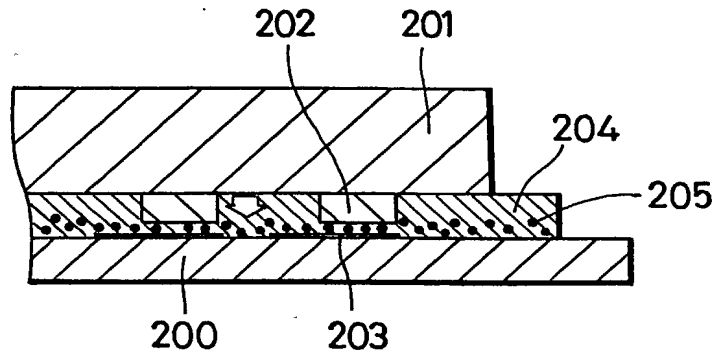


FIG. 10C

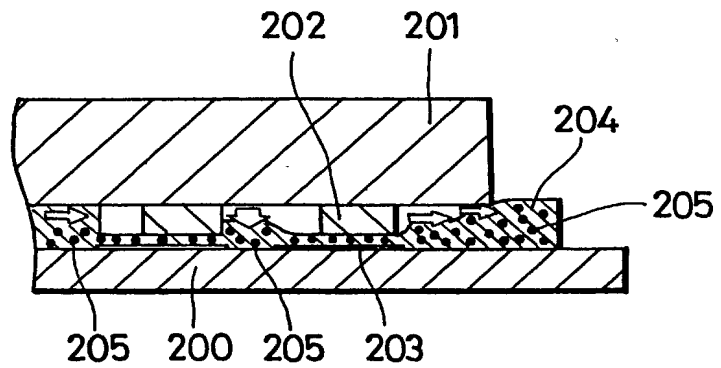


FIG. 10D

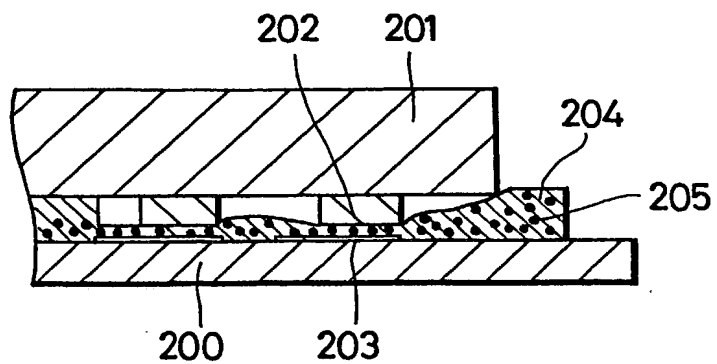


FIG. 11A

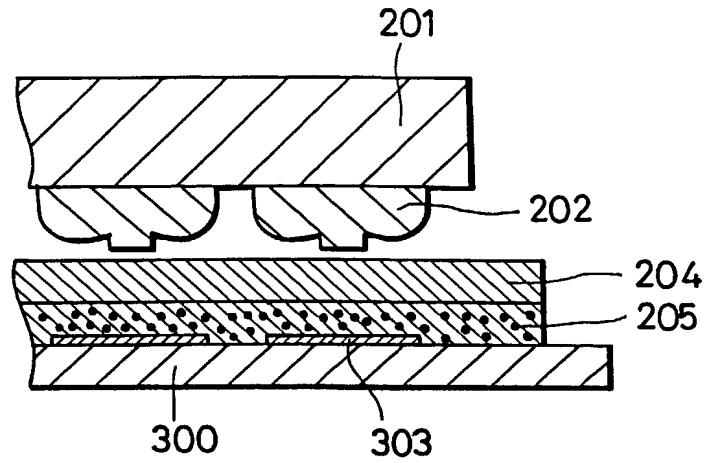


FIG. 11B

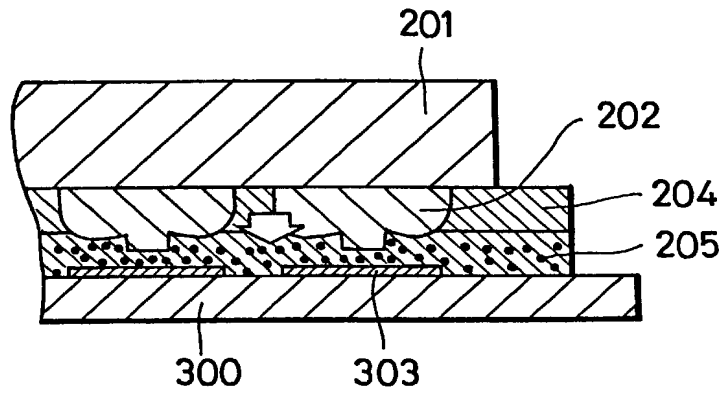


FIG. 11C

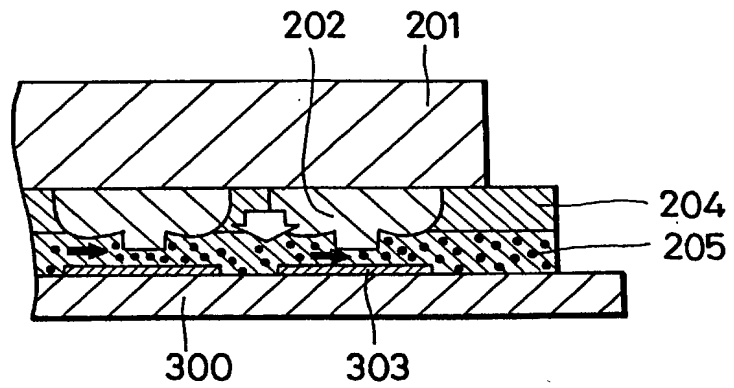
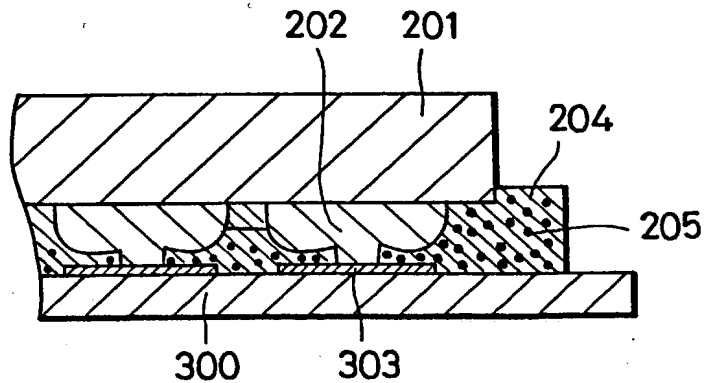


FIG. 11D



DESCRIPTION OF REFERENCE NUMERALS

2 ... IC (second object)
4 ... printed wiring board (first object)
5 ... wiring pattern
6 ... first film-like adhesive layer
7 ... conductive particles
8 ... first binder
9 ... second film-like adhesive layer
9A ... second binder
100 ... electrical connection material
F1 ... first filler
F2 ... second filler